

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
100V	8.5mΩ@10V	60A
	12mΩ@4.5V	

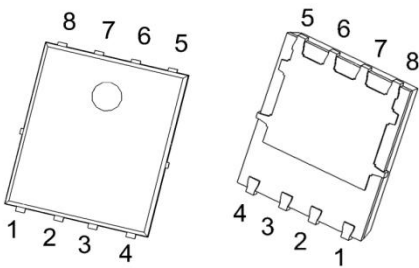
Feature

- Low RDS(on) & FOM
- Extremely low switching loss
- Excellent stability and uniformity
- Fast switching and soft recovery

Applications

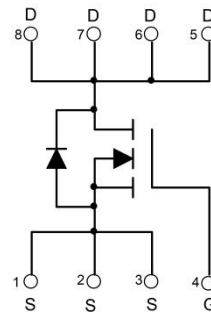
- Consumer electronic power supply
- Motor control Synchronous rectification
- Isolated DC/DC convertor
- Invertors

Package

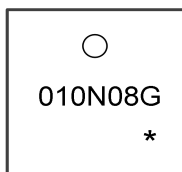


PDFN5X6-8L

Circuit diagram



Marking



010N08G : Product code
* : Month code.

Absolute maximum ratings (Ta=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain source voltage	V_{DS}	100	V
Gate source voltage	V_{GS}	± 20	V
Continuous drain current ¹⁾ , TC=25 °C	I_D	60	A
Pulsed drain current ²⁾ , TC=25 °C	I_{DM}	180	A
Power dissipation ³⁾ , TC=25 °C	P_D	107	W
Single pulsed avalanche energy ⁴⁾	E_{AS}	149	mJ
Thermal resistance, junction-case	$R_{\theta JC}$	1.17	°C/W
Thermal resistance, junction-ambient	$R_{\theta JA}$	62	°C/W
Operation and storage temperature	T_{stg}, T_j	-55 to 150	°C

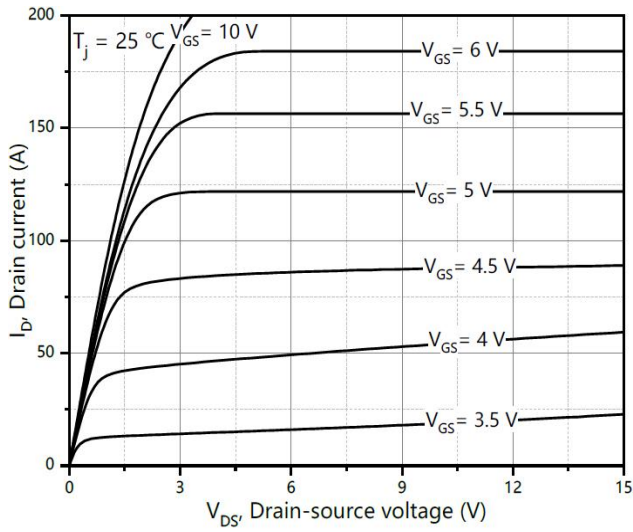
Electrical characteristics (Ta=25°C, unless otherwise noted)

Parameter	Symbol	Test condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-source breakdown voltage	BV_{DSS}	$V_{GS}=0\text{ V}, I_D=250\ \mu\text{A}$	100			V
Drain-source leakage current	I_{DSS}	$V_{DS}=100\text{ V}, V_{GS}=0\text{ V}$			1	μA
Gate-source leakage current	I_{GSS}	$V_{GS}=\pm 20\text{ V}$			± 100	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\ \mu\text{A}$	1	1.9	2.5	V
Drain-source on-state resistance	$R_{DS(ON)}$	$V_{GS}=10\text{ V}, I_D=30\text{ A}$		8.5	11	$\text{m}\Omega$
Drain-source on-state resistance	$R_{DS(ON)}$	$V_{GS}=4.5\text{ V}, I_D=12\text{ A}$		12	16	$\text{m}\Omega$
Dynamic Characteristics						
Input capacitance	C_{iss}	$V_{GS}=0\text{ V}, V_{DS}=50\text{ V}, f=1\text{ MHz}$		1998		pF
Output capacitance	C_{oss}			322		pF
Reverse transfer capacitance	C_{rss}			7.1		pF
Switching Characteristics						
Turn-on delay time	$t_{d(on)}$	$V_{GS}=10\text{ V}, V_{DS}=50\text{ V}, R_G=2.2\ \Omega, I_D=25\text{ A}$		22.1		ns
Rise time	t_r			5.2		ns
Turn-off delay time	$t_{d(off)}$			44		ns
Fall time	t_f			8.4		ns
Total gate charge	Q_g	$I_D=25\text{ A}, V_{DS}=50\text{ V}, V_{GS}=10\text{ V}$		28.9		nC
Gate-source charge	Q_{gs}			6		nC
Gate-drain charge	Q_{gd}			6.8		nC
Drain-Source Diode Characteristics						
Diode forward voltage	V_{SD}	$I_S=30\text{ A}, V_{GS}=0\text{ V}$			1.3	V
Reverse recovery time	t_{rr}	$I_S=12\text{ A}, di/dt=100\text{ A}/\mu\text{s}$		102.9		ns
Reverse recovery charge	Q_{rr}			379		nC
Peak reverse recovery current	I_{rrm}			6.4		A

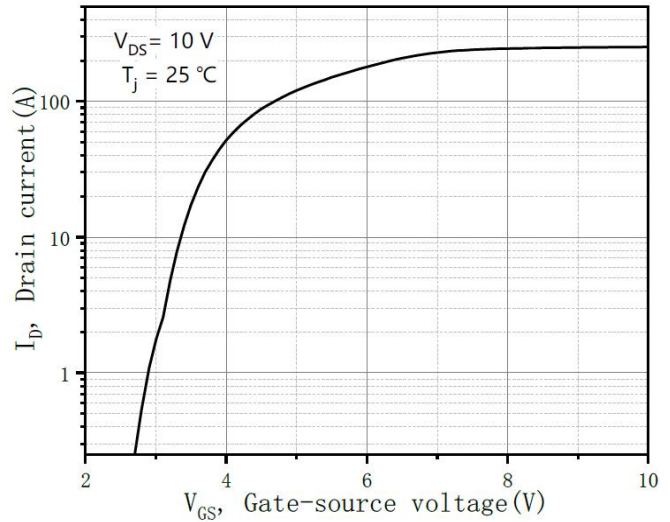
Notes:

- 1) Calculated continuous current based on maximum allowable junction temperature.
- 2) Repetitive rating; pulse width limited by max. junction temperature.
- 3) P_d is based on max. junction temperature, using junction-case thermal resistance.
- 4) $V_{DD}=50\text{ V}, R_G=25\ \Omega, L=0.3\text{ mH}$, starting $T_j=25\ ^\circ\text{C}$.

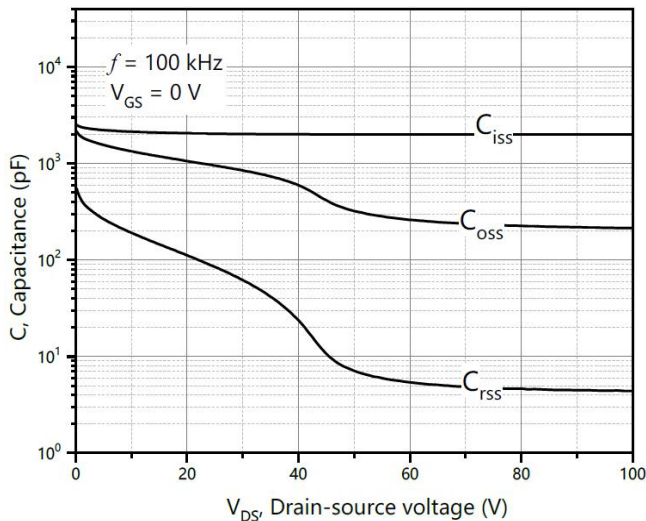
Typical Characteristics



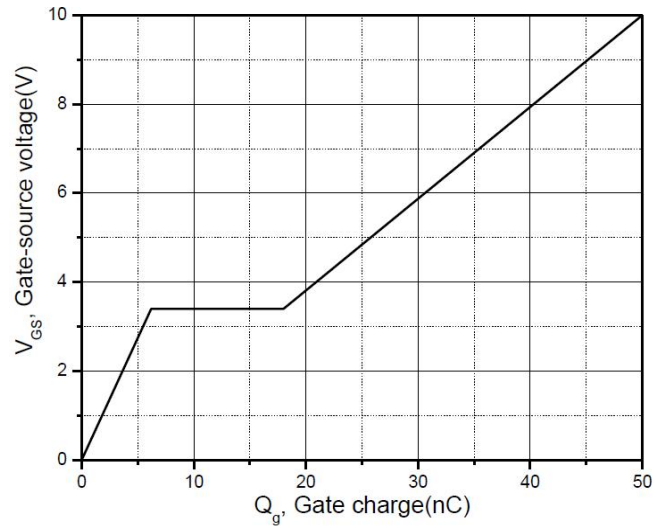
Typ. output characteristics



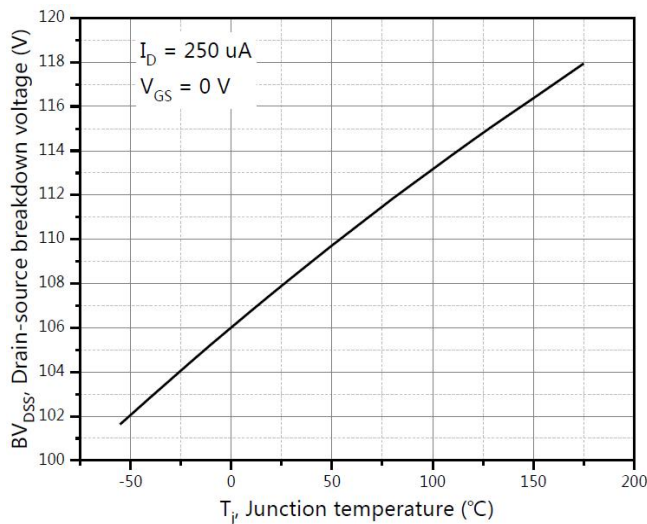
Typ. transfer characteristics



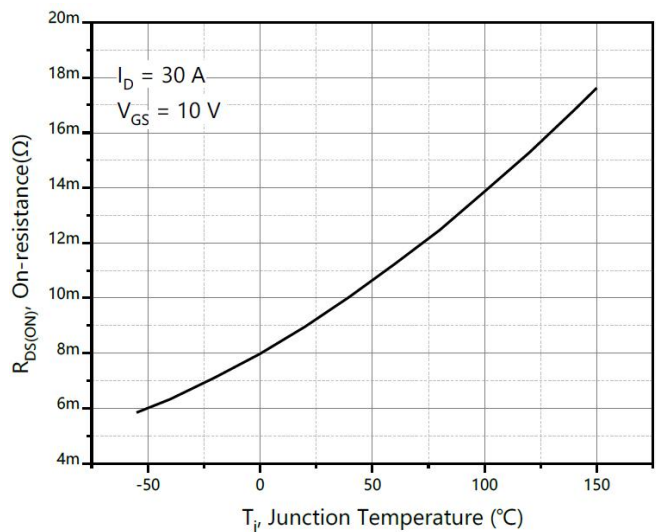
Typ. capacitances



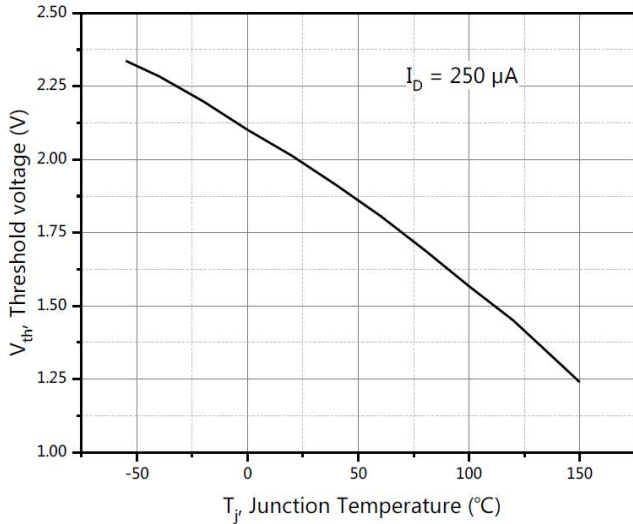
Typ. gate charge



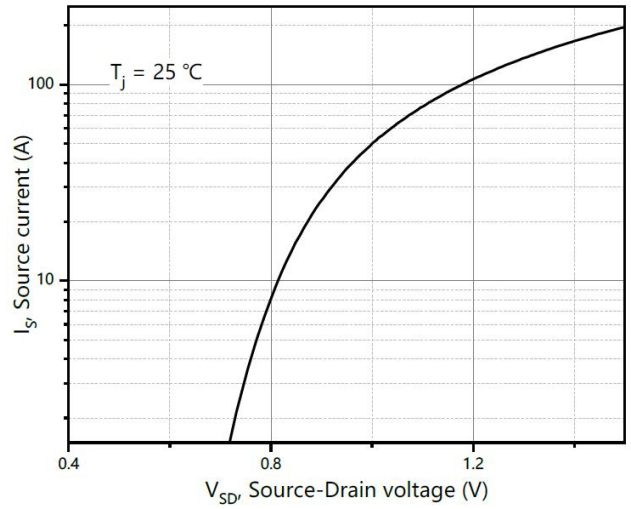
Drain-source breakdown voltage



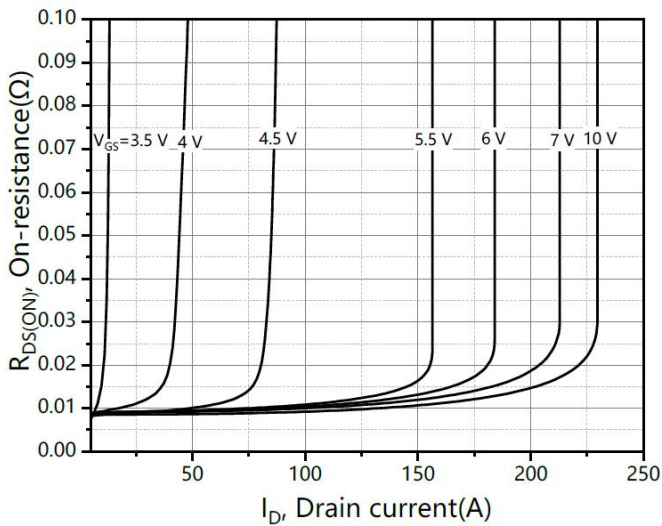
Drain-source on-state resistance



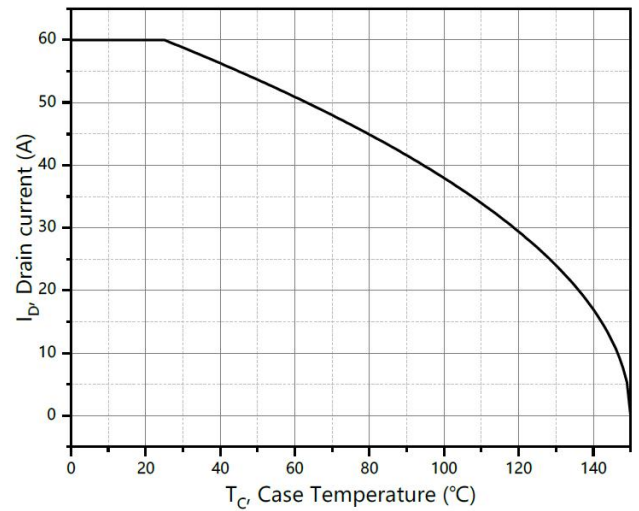
Threshold voltage



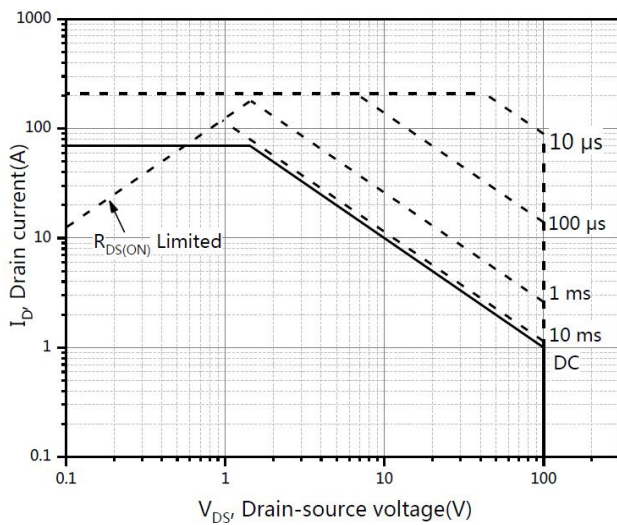
Forward characteristic of body diode



Drain-source on-state resistance



Drain current



Safe operation area TC=25 °C

Test circuits and waveforms

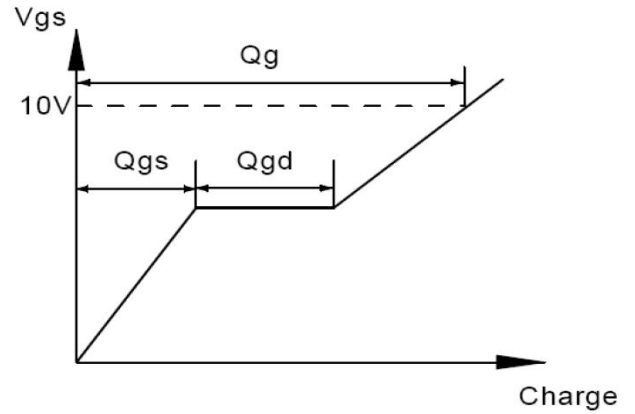
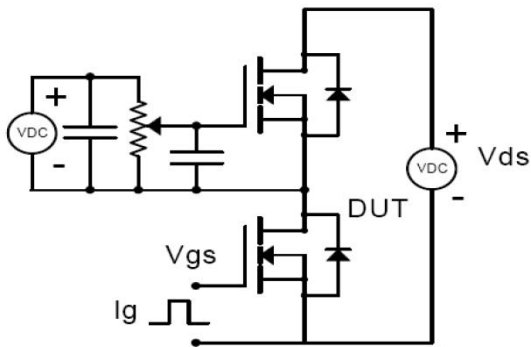


Figure 1, Gate charge test circuit & waveform

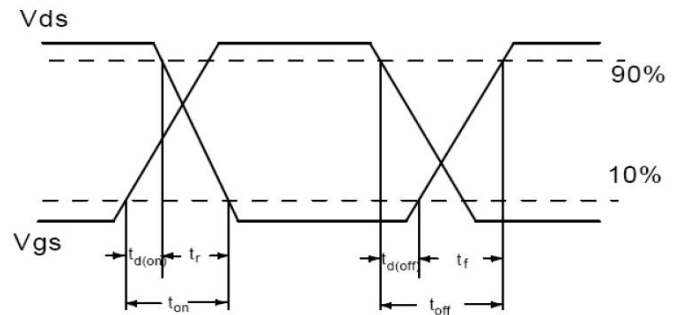
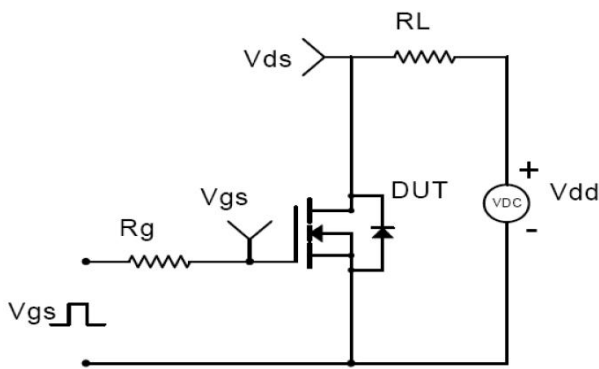


Figure 2, Switching time test circuit & waveforms

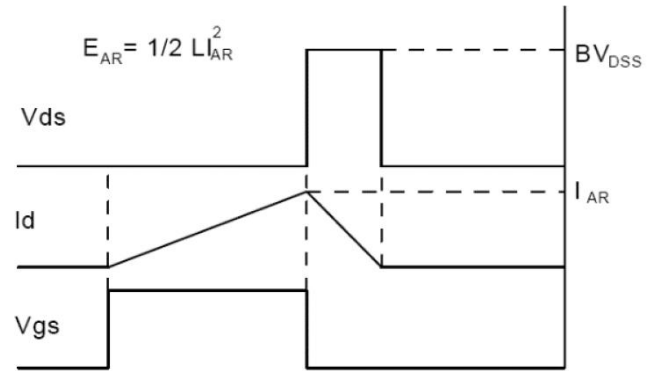
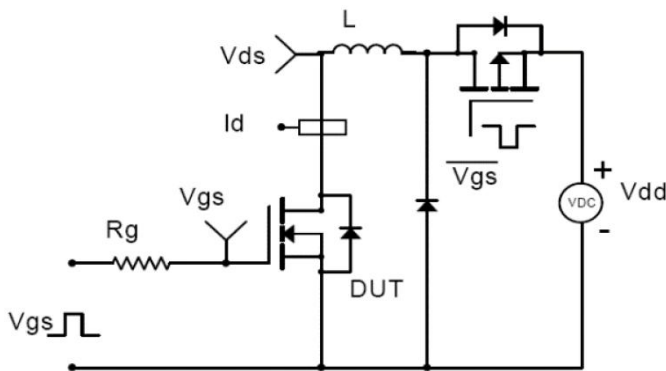


Figure 3, Unclamped inductive switching (UIS) test circuit & waveforms

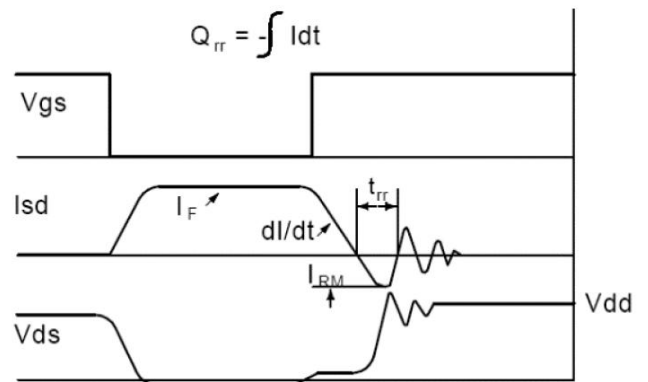
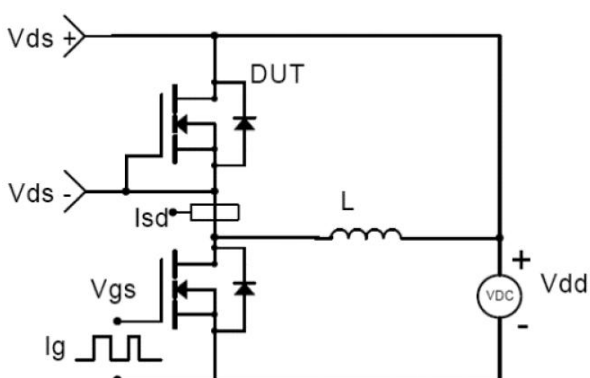
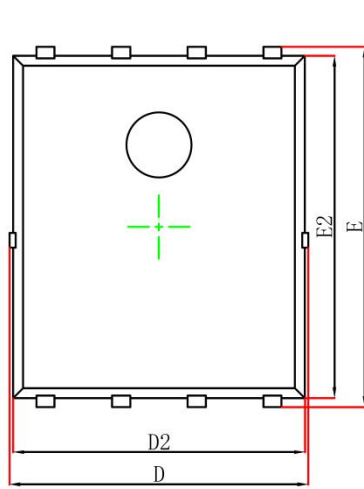


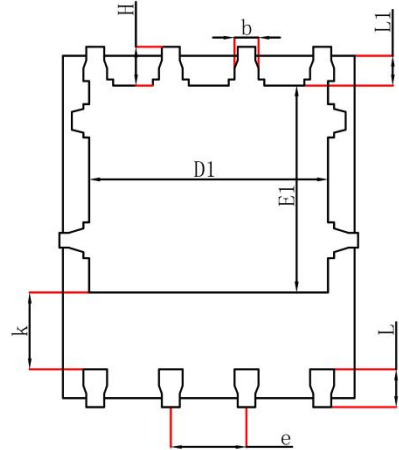
Figure 4, Diode reverse recovery test circuit & waveforms



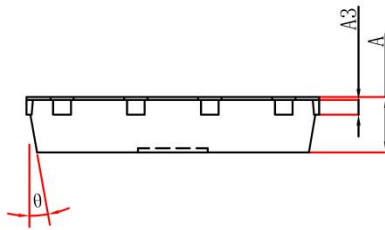
PDFN5X6-8L Package Information



Top View
[顶视图]



Bottom View
[背视图]



Side View
[侧视图]

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.900	1.000	0.035	0.039
A3	0.254REF.		0.010REF.	
D	4.944	5.096	0.195	0.201
E	5.974	6.126	0.235	0.241
D1	3.910	4.110	0.154	0.162
E1	3.375	3.575	0.133	0.141
D2	4.824	4.976	0.190	0.196
E2	5.674	5.826	0.223	0.229
k	1.190	1.390	0.047	0.055
b	0.350	0.450	0.014	0.018
e	1.270TYP.		0.050TYP.	
L	0.559	0.711	0.022	0.028
L1	0.424	0.576	0.017	0.023
H	0.574	0.726	0.023	0.029
θ	10°	12°	10°	12°

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